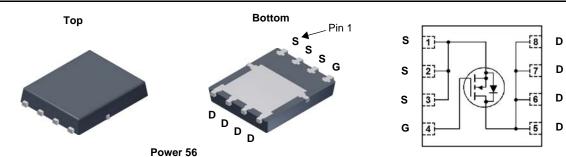


## General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T <sub>C</sub> = 25 °C		26		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	6	Α	
	-Pulsed		30			
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	50	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		48	W	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2.6	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a	) 50	C/vv

### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86105	FDMS86105	Power 56	13 "	12 mm	3000 units

1

October 2014

FAIRCHILD **FDMS86105** 

# N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET **100 V, 26 A, 34 m**Ω

### Features

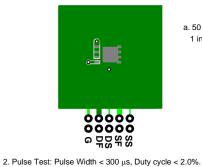
- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)} = 54 \text{ m}\Omega \text{ at } V_{GS} = 6 \text{ V}, I_D = 4.5 \text{ A}$
- MSL1 robust package design
- 100% UIL tested



FDMS86105 N
N-Channel S
Shielded G
bhielded Gate PowerTrench <sup>®</sup>
[rench <sup>®</sup> MC
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
				196	max	Units	
	cteristics			1	1	1	
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, V_{GS} = 0 \ V$	100			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		70		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			1	μΑ	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	2.8	4.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_{I}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 V, I_{D} = 6 A$		27	34		
		$V_{GS} = 6 V, I_D = 4.5 A$		37	54	mΩ	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A, T <sub>J</sub> = 125 °C		46	57		
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 V, I_{D} = 6 A$		15		S	
C <sub>iss</sub>	Characteristics Input Capacitance	Vac = 50 V. Vac = 0 V		483	645	pF	
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 50 V, V_{GS} = 0 V,$		114	155	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1 MHz		5	10	pF	
R <sub>g</sub>	Gate Resistance			0.9		Ω	
Switching	Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			6.7	14	ns	
t <sub>r</sub>	Rise Time	$V_{DD} = 50 V, I_{D} = 6 A,$		2.1	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		12	22	ns	
t <sub>f</sub>	Fall Time			2.4	10	ns	
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		7.5	11	nC	
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V,$		4.2	6	nC	
Q <sub>gs</sub>	Gate to Source Charge	$I_D = 6 A$		2.1		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			1.7		nC	
Drain-Soເ	Irce Diode Characteristics						
V <sub>SD</sub>		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.76	1.2		
	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 6 A$ (Note 2)		0.82	1.3	V	
t <sub>rr</sub>	Reverse Recovery Time			38	61	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	— I <sub>F</sub> = 6 A, di/dt = 100 A/μs		32	51	nC	

Notes: 1. R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



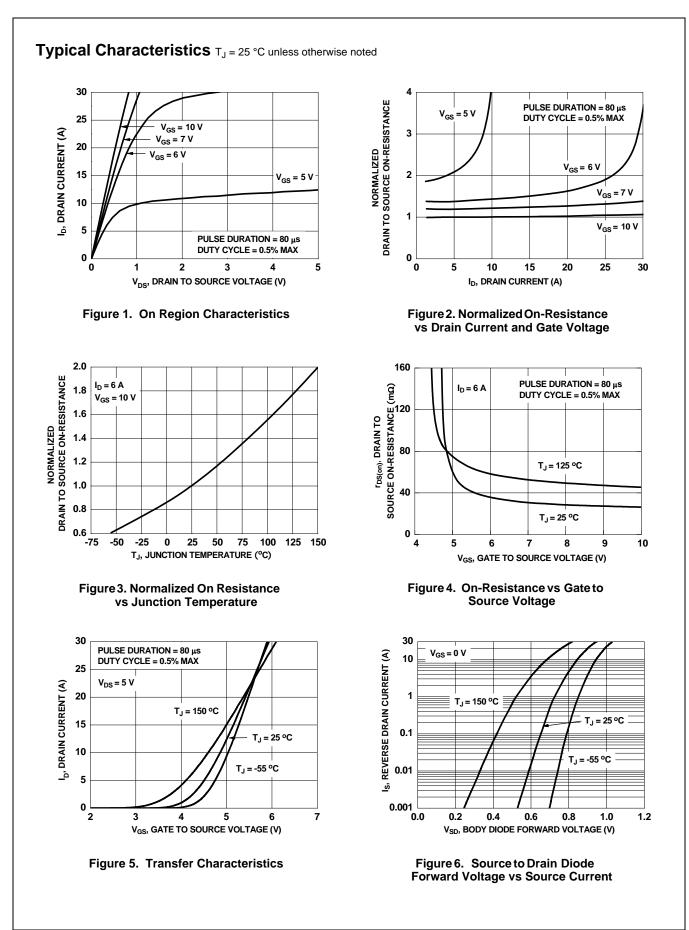
3. Starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 10 A,  $V_{DD}$  = 90 V,  $V_{GS}$  = 10 V.

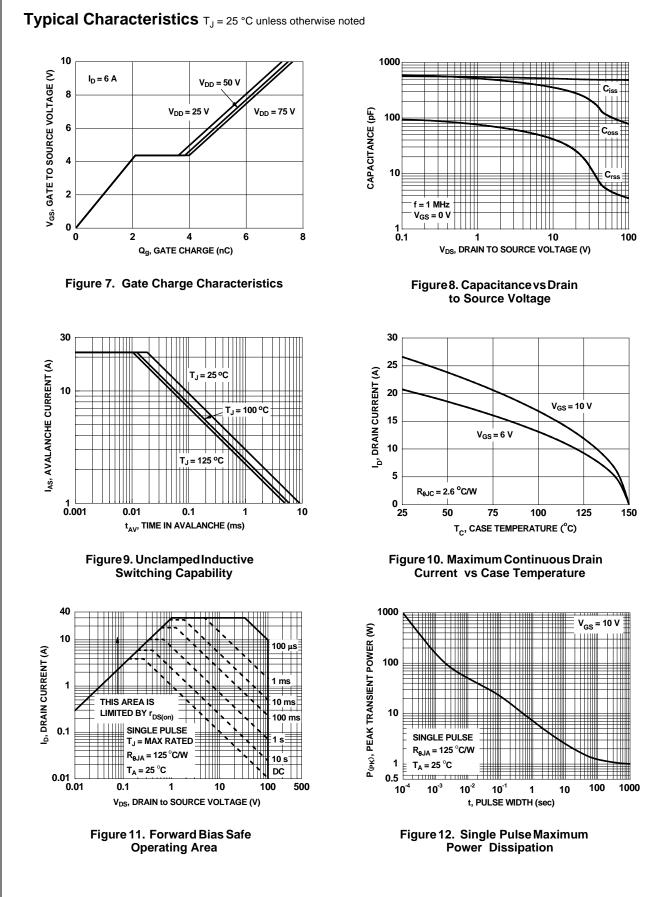
1 in<sup>2</sup> pad of 2 oz copper.

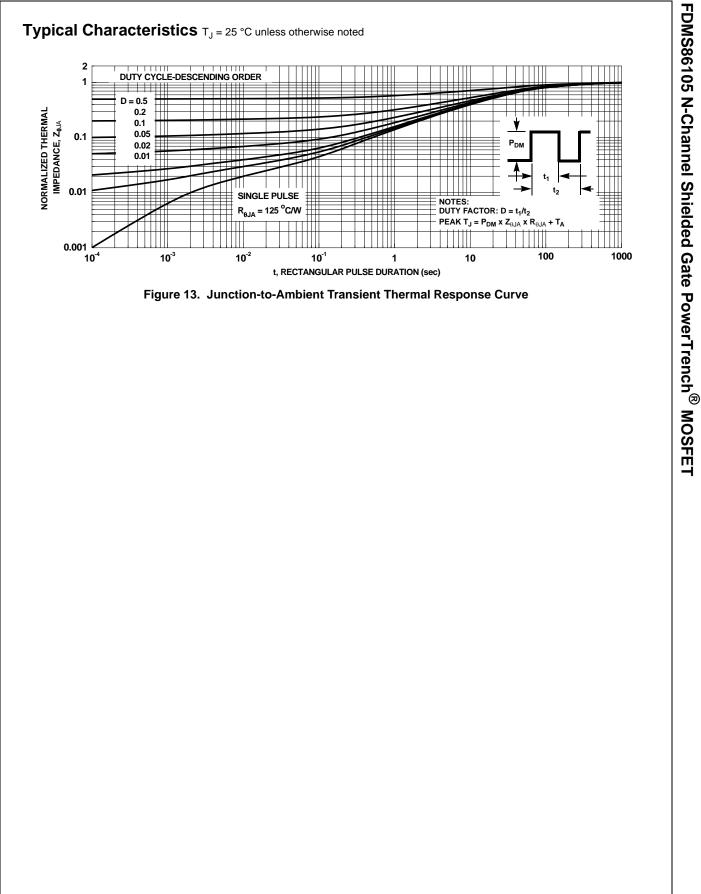
a. 50 °C/W when mounted on a

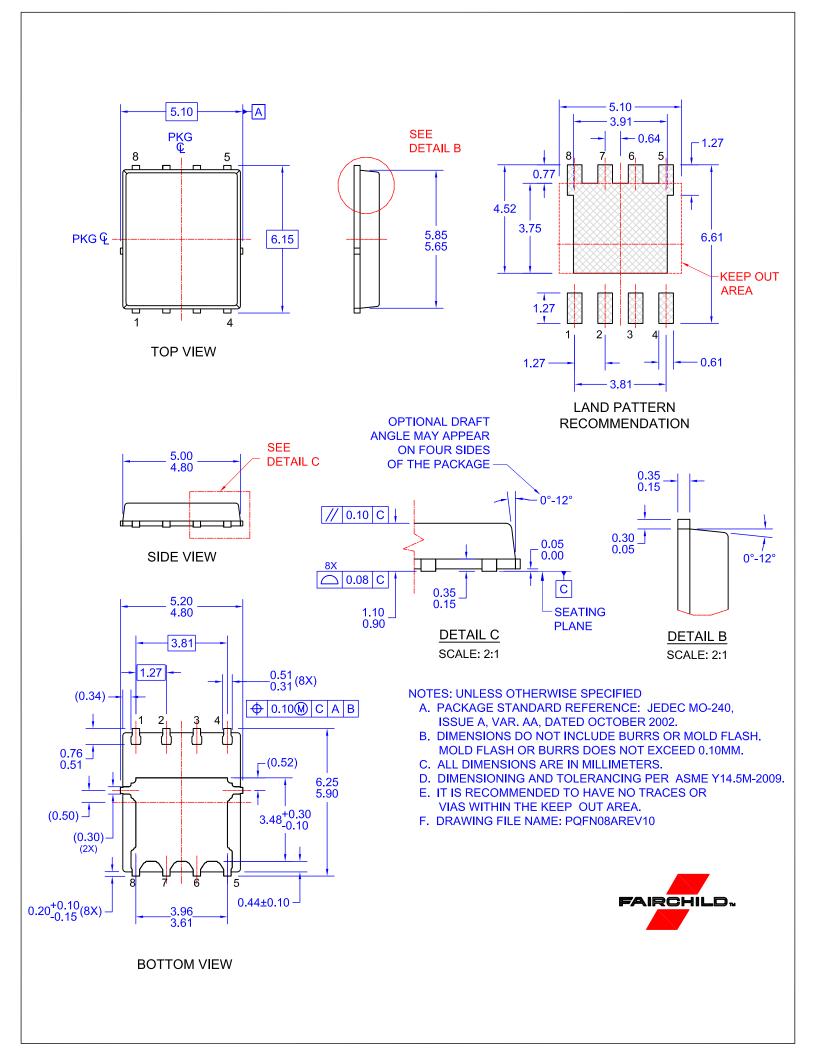


b. 125 °C/W when mounted on a minimum pad of 2 oz copper.











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